

Title (en)

BONDING METHOD WHICH CAN BE APPLIED TO FUEL CELLS

Title (de)

BONDINGVERFAHREN ZUR ANWENDUNG BEI BRENNSTOFFZELLEN

Title (fr)

PROCÉDÉ DE COLLAGE - APPLICATION AUX PILES À COMBUSTIBLES

Publication

EP 3931897 A1 20220105 (FR)

Application

EP 20713721 A 20200225

Priority

- FR 1901963 A 20190226
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Abstract (en)

[origin: WO2020173853A1] The invention relates to a method for bonding a first component (1) to a second component (2), involving the following steps: - depositing, onto the first component (1) and/or onto the second component (2), an adhesive means of a first type selected from a slow-setting adhesive means (3) or a quick-setting adhesive means (4), - depositing, onto the first component (1) and/or onto the second component (2), an adhesive means of a second type which differs from the first type, selected from a slow-setting adhesive means (3) or a quick-setting adhesive means (4), - bringing the two components (1, 2) into contact, - pressing, and - setting the slow-setting adhesive means (3). The invention can be applied in the assembly of a bipolar plate (6). The invention can be applied in the assembly of a fuel cell (7).

IPC 8 full level

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